



# ***Alpha & Omega Semiconductor Product Reliability Report***

**AOZ2338CQI-01**, rev A

**Plastic Encapsulated Device**

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This AOS product reliability report summarizes the qualification results for AOZ2338CQI-01 in QFN5x5-28L package. Accelerated environmental tests are performed on a specific sample size and samples are electrically tested before and after each time point. Review of final electrical test results confirm that AOZ2338CQI-01 pass the AOS quality and reliability requirements. The released products will be categorized by its process family and routinely monitored for continuous improvement of product quality.

## I. Reliability Stress Test Summary and Results

| Test Item                   | Test Condition   | Time Point                 | Total Sample Size | Number of Failures | Reference Standard |
|-----------------------------|--|----------------------------|-------------------|--------------------|--------------------|
| HTOL                        | T <sub>J</sub> = 125°C,<br>V <sub>IN</sub> = V <sub>ccmax</sub>                            | 168 / 500 /<br>1000 hours  | 231 pcs           | 0                  | JESD22-A108        |
| Preconditioning<br>(Note A) | T <sub>A</sub> = 30°C, RH = 60% +<br>3 cycle reflow @ 260°C<br>(MSL 3)                     | 192 hours                  | 693 pcs           | 0                  | JESD22-A113        |
| HAST                        | T <sub>A</sub> = 130°C, RH = 85%,<br>P = 33.3psia,<br>V <sub>IN</sub> = V <sub>ccmax</sub> | 96 hours                   | 231 pcs           | 0                  | JESD22-A110        |
| Autoclave                   | T <sub>A</sub> = 121°C, RH = 100%,<br>P = 29.7psia   | 96 hours                   | 231 pcs           | 0                  | JESD22-A102        |
| Temperature Cycle           | T <sub>A</sub> = -65°C to 150°C,<br>air to air   | 250 / 500 /<br>1000 cycles | 231 pcs           | 0                  | JESD22-A104        |

**Note:** The reliability data presents total of available generic data up to the published date.

Note A: MSL (Moisture Sensitivity Level) 3 based on J-STD-020

## II. Reliability Evaluation

**FIT rate (per billion): 50.97**

**MTTF = 2240 years**

The presentation of FIT rate for the individual product reliability is restricted by the actual burn-in sample size. Failure Rate Determination is based on JEDEC Standard JESD 85. FIT means one failure per billion hours.

**Failure Rate** =  $\text{Chi}^2 \times 10^9 / [2 (N) (H) (Af)] = 50.97$

**MTTF** =  $10^9 / \text{FIT} = 2240$  years

**Chi<sup>2</sup>** = Chi Squared Distribution, determined by the number of failures and confidence interval

**N** = Total Number of units from burn-in tests

**H** = Duration of burn-in testing

**Af** = Acceleration Factor from Test to Use Conditions (E<sub>a</sub> = 0.7eV and T<sub>use</sub> = 55°C)

Acceleration Factor [**Af**] =  $\text{Exp} [E_a / k (1/T_{j u} - 1/T_{j s})]$

**Acceleration Factor ratio list:**

|    | 55 deg C | 70 deg C | 85 deg C | 100 deg C | 115 deg C | 125 deg C |
|----|----------|----------|----------|-----------|-----------|-----------|
| Af | 77       | 26       | 9.8      | 3.9       | 1.7       | 1         |

T<sub>j s</sub> = Stressed junction temperature in degree (Kelvin), K = C + 273.16

T<sub>j u</sub> = The use junction temperature in degree (Kelvin), K = C + 273.16

**k** = Boltzmann's constant, 8.617164 X 10<sup>-5</sup>eV / K

### III. ESD and Latch Up Test Results

| Test   | Test Conditions                         | Total Sample Size | Number of Failures | Reference Standard |
|--|---|-------------------|--------------------|--------------------|
| Electrostatic Discharge Human Body Model     | T <sub>A</sub> = 25°C, +/-2kV           | 3                 | 0                  | JESD-A114          |
| Electrostatic Discharge Charged Device Model | T <sub>A</sub> = 25°C, +/-1kV           | 3                 | 0                  | JESD-C101          |
| Latch Up                                     | T <sub>A</sub> = 25°C, +/-200mA, 6V/26V | 6                 | 0                  | JESD78             |
| Latch Up                                     | T <sub>A</sub> = 85°C, +/-200mA, 6V/26V | 6                 | 0                  | JESD78             |

(1) ATE results are used to determine PASS/FAIL. Parametric shift <10%.

